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FAIRCHILD

SEMICONDUCTOR TM

FQPF9N08L **80V LOGIC N-Channel MOSFET**

General Description

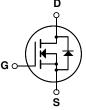
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand a high energy pulse in the avalanche and commutation modes. These devices are well suited for low voltage applications such as automotive, high efficiency switching for DC/DC converters, and DC motor control.

Features

- + 7.0A, 80V, $R_{DS(on)}$ = 0.21 Ω @V_{GS} = 10 V + Low gate charge (typical 4.7 nC)
- Low Crss (typical 16 pF) •
- Fast switching
- · 100% avalanche tested
- Improved dv/dt capability
- 175°C maximum junction temperature rating
- · Low level gate drive requirements allowing direct operation from logic drives





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQPF9N08L	Units	
V _{DSS}	Drain-Source Voltage		80	V	
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		7.0	A	
	- Continuous (T _C = 100°C)		4.95	A	
I _{DM}	Drain Current - Pulsed	(Note 1)	28	A	
V _{GSS}	Gate-Source Voltage		± 20	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	55	mJ	
I _{AR}	Avalanche Current	(Note 1)	7.0	А	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	2.3	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.5	V/ns	
PD	Power Dissipation ($T_C = 25^{\circ}C$)		23	W	
	- Derate above 25°C		0.15	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C	
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

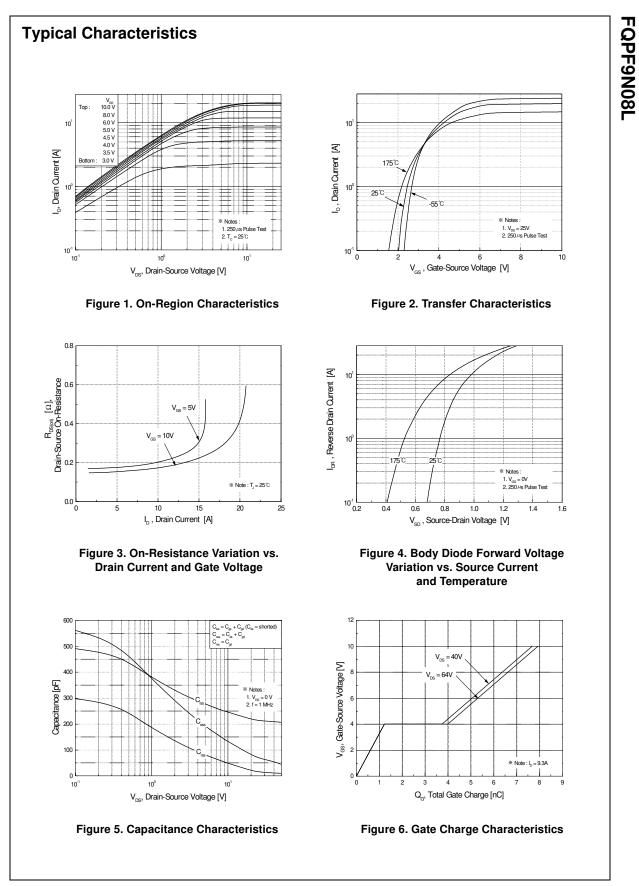
Symbol	Parameter	Тур	Max	Units
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case		6.52	°C/W
$R_{ hetaJA}$	DJA Thermal Resistance, Junction-to-Ambient		62.5	°C/W

FQPF9N08L

December 2000

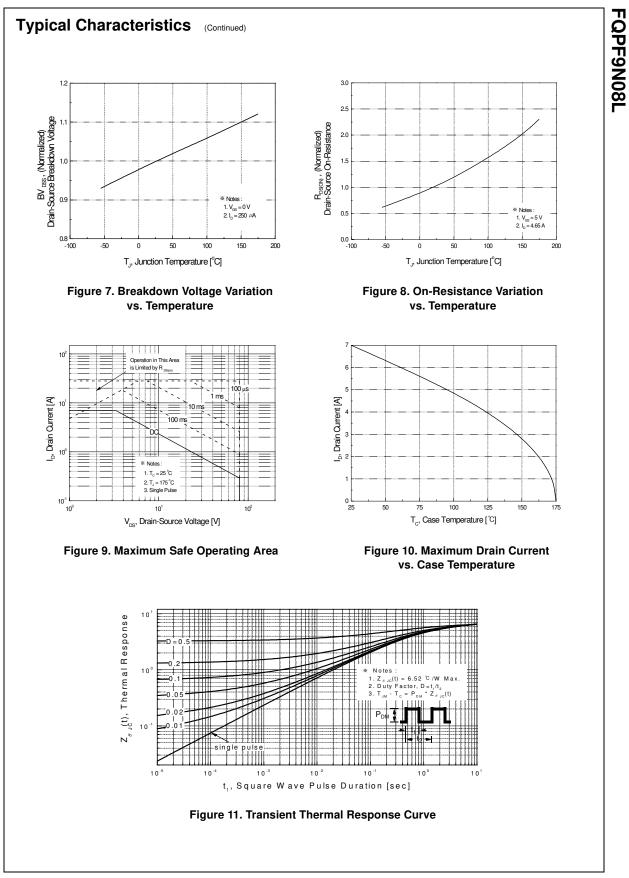
TM

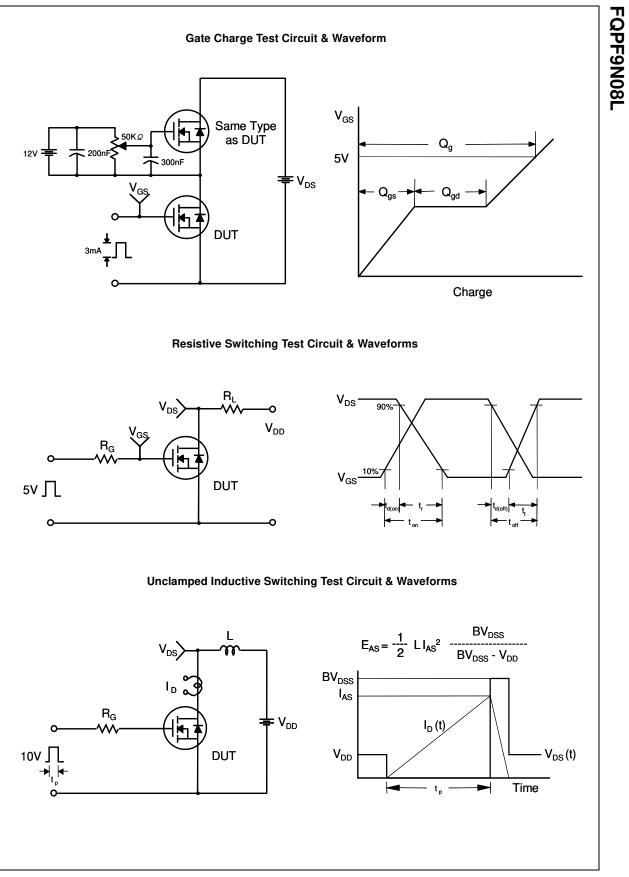
Symbol	Parameter	Test Conditions	1	Min	Тур	Max	Units
Off Cha	racteristics						
3V _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$		80			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu$ A, Referenced to 25°C			0.08		V/°C
I _{DSS}		$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
	Zero Gate Voltage Drain Current	V _{DS} = 64 V, T _C = 150°C				10	μA
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA
on Cha	restariation						
/ _{GS(th)}	racteristics Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1.0		2.0	V
R _{DS(on)}	Static Drain-Source $V_{GS} = 10 \text{ V}, I_D = 3.5 \text{ A}$			1.0	0.15	0.21	•
-DS(on)	On-Resistance	V _{GS} = 5 V, I _D = 3.5 A	5			0.23	Ω
ĴFS	Forward Transconductance	$V_{DS} = 25 \text{ V}, \text{ I}_{D} = 3.5 \text{ A}$	(Note 4)		4.75		S
		-				I	I
	c Characteristics	I				1	[
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			215	280	pF
C _{oss}	Output Capacitance				70	90	pF
Srss	Reverse Transfer Capacitance				16	20	pF
Switchi	ng Characteristics						
d(on)	Turn-On Delay Time				6.5	23	ns
r	Turn-On Rise Time	$V_{DD} = 40 \text{ V}, \text{ I}_{D} = 9.3 \text{ A},$			180	370	ns
d(off)	Turn-Off Delay Time	R _G = 25 Ω			13	35	ns
f	Turn-Off Fall Time	(Note 4, 5)			30	70	ns
2 _g	Total Gate Charge	$V_{DS} = 64 \text{ V}, \text{ I}_{D} = 9.3 \text{ A},$ $V_{GS} = 5 \text{ V}$			4.7	6.1	nC
Ω _{gs}	Gate-Source Charge				1.2		nC
2 ^{gd}	Gate-Drain Charge	45	(Note 4, 5)		2.8		nC
0	-	L					
	ource Diode Characteristics an	0	S				-
S	Maximum Continuous Drain-Source Dic					7.0	A
SM	Maximum Pulsed Drain-Source Diode F					28	A
/ _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 7.0 A$				1.5	V
rr	Reverse Recovery Time	$\label{eq:GS} \begin{array}{l} V_{GS} = 0 \mbox{ V, } I_S = 9.3 \mbox{ A,} \\ \\ dI_F \mbox{ / } dt = 100 \mbox{ A/} \mu s \end{array} \tag{Note 4}$			54		ns
¢ _{rr}	Reverse Recovery Charge				80		nC
_ = 1.54mH,	ating : Pulse width limited by maximum junction temper $I_{AS} = 7.0A, V_{DD} = 25V, R_G = 25 \Omega, Starting T_J = 25^{\circ}C$ $I/dt \leq 300A/\mu s, V_{DD} \leq BV_{DSS}$, Starting T_J = 25^{\circ}C					_	



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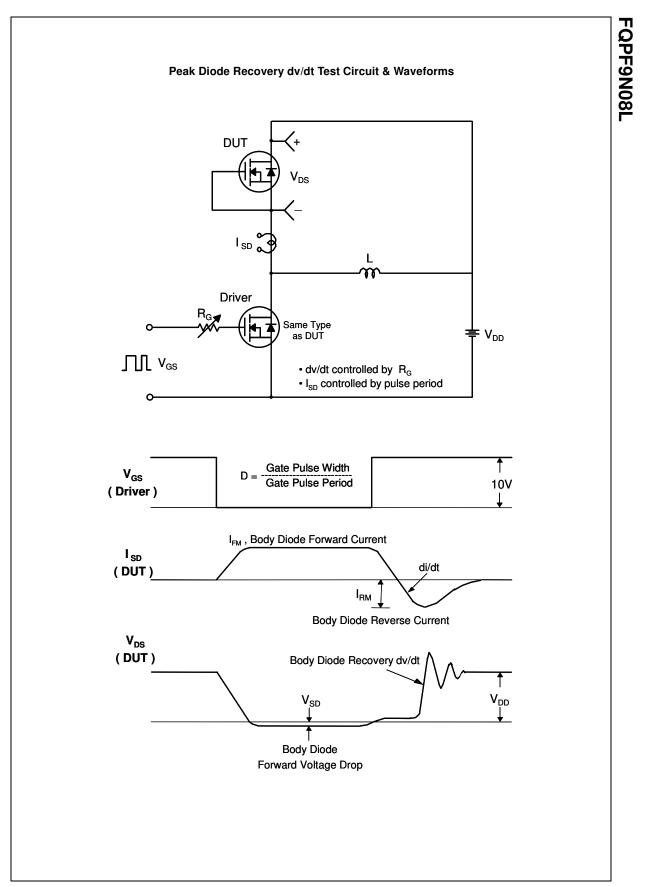
Rev. A2, December 2000



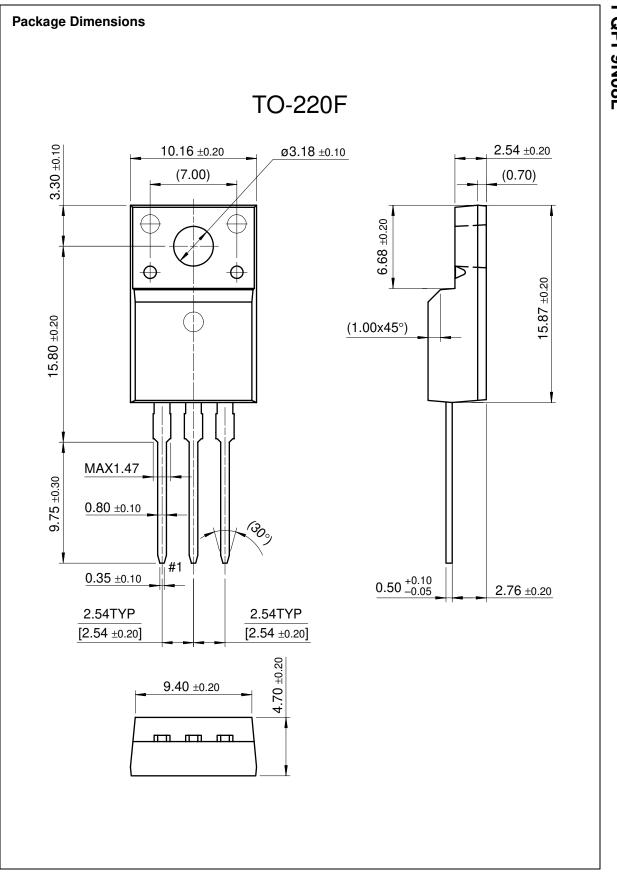


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